

APPLICATION DATA SHEET**Application Information**

Application Type:: Regular
Subject Matter:: Utility
CD-ROM or CD-R?:: No
Number of CD Disks:: 0
Number of Copies of CDs:: 0
Sequence Submission?:: No
Computer Readable Form (CRF)?:: No
Number of Copies of CRF:: 0
Title:: System and Method to Reduce Metal
Series Resistance of Bumped Chip
Attorney Docket Number:: GWS-005
Request for Early Publication?:: No
Request for Non-Publication?:: No
Suggested Drawing Figure::
Total Drawing Sheets:: 5
Small Entity?:: No
Licensed US Govt. Agency:: No
Contract or Grant Numbers::
Secrecy Order in Parent Appl.?:: No

Applicant Information

Applicant Authority Type:: Inventor
Primary Citizenship Country:: U.S.
Status:: Full Capacity
Given Name:: David
Middle Name:: N.
Family Name:: Okada
Name Suffix::
City of Residence:: Chandler
State or Province of Residence:: Arizona
Country of Residence:: U.S.

Street of Mailing Address:: 5681 W. Park Ave.
City of Mailing Address:: Chandler
State or Province of Mailing Address:: Arizona
Country of Mailing Address:: U.S.
Postal or Zip Code of Mailing Address:: 85226

Correspondence Information

Correspondence Customer Number:: 051414

Representative Information

Representative Customer Number:: 051414

Domestic Priority Information

Application::	Continuity Type::	Parent Application::	Parent Filing Date::
This application	National Stage of	PCT/US2004/040698	12/03/04
PCT/US2004/040698	Claims priority to	60/527,463	04/12/03

Foreign Priority Information

Country::	Application Number::	Filing Date::	Priority Claimed::
		MM/DD/YY	

Assignee Information

Assignee Name:: Great Wall Semiconductor Corporation
City of Mailing Address:: Tempe
State or Province of Mailing Address:: Arizona
Country of Mailing Address:: U.S.A.